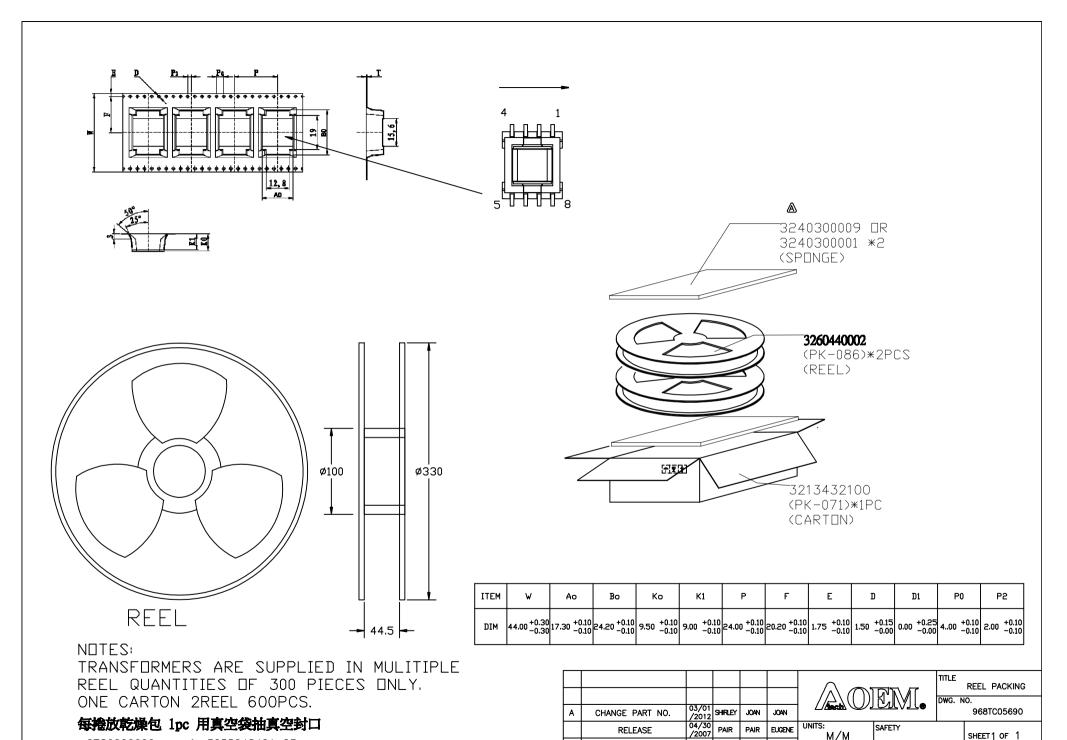


## ELECTRICAL CHARACTERISTICS:

- 1. DCR : PIN 1,2 12,11 = 130m $\Omega$  MAX. PIN 3-10 = 165m $\Omega$  MAX PIN 5,6 - 8,7 = 9m $\Omega$  MAX.
- 2. INDUCTANCE (@250KHz, 0.3Vrms) : PIN  $1-12 = 2-11 = 40\text{uH}\pm10\%$  (2.1ADC) : PIN 1-12 = 2-11 = 36uH MIN.
- 3. TURN RATIO : PIN 1-12 :  $5-8 = 5.5 \pm 3\%$ PIN 1-12 :  $3-10 = 2.75 \pm 3\%$
- 4. HI-POT (@1.5KVAC, 1mA, 1SEC): PIN 1,2,12,11 TO 8,7,6,5. (@500VAC, 1mA, 1SEC): Winding TO CORE.
- ∆ 5. OPERATING TEMPERATURE RANGE : -40°C ~ +85°C
  - 6. RoHS COMPLIANT

	CHANGE	00/00				() (D)	<u> </u>	TITLE TR	Flyback RANSFORMER
В	ELECTRICAL CHARACTERISTICS	/2014	SHIRLEY	BETTY	BETTY		K*IV/II_	DWG. N	10.
Α	CHANGE PIN#1 LOCATION	/2012	SHIKLEY	BETTY	BETTY				ATS-934R
	RELEASE	02/20 /2012	SHIRLEY	BETTY	BETTY	UNITES: M/M	SAFETY		SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	снк	APPD	, , , , ,	5.41		
	REVIS		DATE 02/20/2012	P/N:		DRAW SHIRLEY			



DATE BY

**REVISIONS** 

CHK

04/30/07

DRAW

Pair

DESCRIPTION

2780000000

**A** 3255048421 OR 3255048420



## Pb-free Soldering IR Reflow(SMD)



1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85% 2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

	IR reflow profile	Pb-free	
step#	Profile Feature	Condition/Duration	
step1	Ramp-up rate	3°C/second max	
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds	
step3	Ramp-up rate(TL to Tp)	3°C/second max	
sieps	Temperature maintained above 217°C	60-150seconds	
ston/	Peak temperature(Tp)	260+0/-5℃	
step4	Time within 5°C of actual peak temperature	30seconds max	
	Ramp-down rate(Tp to TL)	6°C/second max	

## 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

	,					
Package	Volume mm <sup>3</sup>	Volume mm <sup>3</sup>	Volume mm <sup>3</sup>			
Thickness	<350	350-2000	>2000			
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5℃			
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5℃			
>2.5mm	250+0/-5° <b>C</b>	245+0/-5°C	245+0/-5℃			